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Preparation Properties and Device Application of β -Ga₂O₃: A Review

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Abstract: Extremely wide-bandgap β -Ga₂O₃ is a new way semiconducting has wide range of application such as electronics devices operated at high temperature and short-wavelength optoelectronics. It has a wide bandgap of 4.5eV -4.9 electron volt (eV) and great thermal stabilization up to 1400°C, opening new possibilities for various device applications. The development of β -Ga₂O₃ thin film growth, characteristics, and device demonstrations is reviewed in this study. The methods used to demonstrate great-quality β -Ga₂O₃ thin film growth with controlled doping are discussed. Monoclinic β -Ga₂O₃ applications in devices are also discussed. Finally, a conclusion will be offered and future research perspectives on this key semiconducting material.

Keywords: Ga₂O₃, optoelectronic devices, Structure of Ga₂O₃, Photodetector,

I. INTRODUCTION

Ultrawide bandgap (UWBG) semiconductor material (Ga₂O₃) coming out as a new generation power devices operating at high voltages in electronics and deep ultraviolet (DUV) star blind photodetectors contribute to its distinctive material characteristics. There are various polymorphs which are named as (α , β , γ , δ and ϵ), β -Ga₂O₃ with a monoclinic crystal structure represents the foremost thermally stable material. β -Ga₂O₃ contains a temperature bandgap ~4.5-4.9 eV. It additionally has wonderful chemical, mechanical- strength and thermal-stability at elevated temperatures variation . because of its ultrawide bandgap that similarize to the cut-off wavelength equivalent to 250 nm, β -Ga₂O₃ is solar-blind. As a result, DUV photodetectors supported not need any supplementary filter. It additionally avoids alloying and therefore simplifies the fabric growth method. Moreover, β -Ga₂O₃ primarily based on field result transistors, diodes will have great device properties which includes large breakdown voltage aalongwith high power and low loss because of its terribly massive bandgap. Coordinative relationship exhibit between the bandgap E_g and breakdown electrical fields ,the E_{br} of β -Ga₂O₃ is predicted to be worth 6-8 MV/cm [1]. Higher value of E_{br} is fascinating property of β -Ga₂O₃ as a result of the Baliga's figure-of-merit (FOM), parameter to judge however appropriate a cloth is for power devices, diect effect to E_{br} however, is merely linearly variation to quality. As compared to a GaN, the conductivity loss of β -Ga₂O₃ power devices may be similar to one order of magnitude lower at constant breakdown voltage. a lot of well, top-quality top quality can be synthesized in massive volumes by climbable and low-price melt-growth techniques. This addresses these industrial constraints of attack and GaN primarily based device technologies that lack reasonable native substrates. Scientific studies and analysis in β -Ga₂O₃ has greatly point of interaction recently.

II. FEAUTURES OF β -Ga₂O₃

A. Structure Of β -Ga₂O₃

Among all different structure of metallic element compounds, This material has involved the attraction due to handiness and speculative properties. At a given temperature, it is stable and variation takes place until melting point. β -Ga₂O₃ exhibit a C-centered monoclinic building block with C2/m space . It holds some crystallographically idistinguishable one Gallium positions, one of the atom is tetrahedral (I) and the another octahedral Gallium (II). O₂ have some crystallographically various dimension and area units depicted as O (1st), O (2nd) and O (3rd), severally. Area of 2O₂ unit synchronal trigonally and another is synchronized tetrahedrally. Ga₂O₃ is a TCO that can take on a variety of polymorphs, including and [2], which act as conductor or insulators reliant upon the improved circumstances used. Distinctive band alignments can be found in each polymorph [3]. Furthermore, in the crystal lattice, all polymorphic have somewhat different material properties. Polymorphs differ from each other in a variety of ways. Including characteristics of the crystal space and the quantity of Ga³⁺. In coordination Under certain conditions, each polymorph displays its Ga₂O₃ phases. Under specific circumstances [4]. The the phases are defective spinel (γ -Ga₂O₃), rhombohedral (α -Ga₂O₃), cubic (δ -Ga₂O₃), monoclinic (β -Ga₂O₃), , and orthorhombic of (ϵ -Ga₂O₃) crystal structure are among the polymorphs of Ga₂O₃ [5].

Figure 1 depicts well-known polymorph crystal formations. These polymorphs, which are members of the Ga_2O_3 family, have distinct structures.

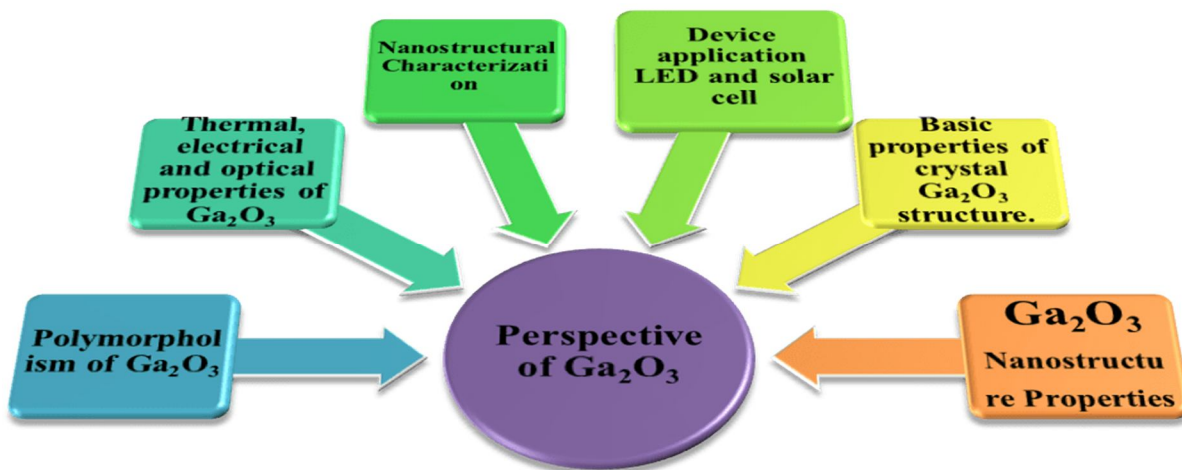


Figure 1 Properties of Ga_2O_3 .

Among all Ga_2O_3 , β - Ga_2O_3 is largest stable at polymorphic phase. The interconversion connection between Ga_2O_3 and other elements is depicted in polymorphs. α - Ga_2O_3 can be transformed into β - Ga_2O_3 by heating it to above $600^\circ C$. Meanwhile, only γ - Ga_2O_3 and δ - Ga_2O_3 are possible. Under dry conditions, they were heated to temperatures of $650^\circ C$ and $870^\circ C$ consecutively, to transform them into the β - Ga_2O_3 phase. In contrast, δ - Ga_2O_3 can only be converted to β - Ga_2O_3 when heated to $300^\circ C$ in a moist environment as described in Figure 2.

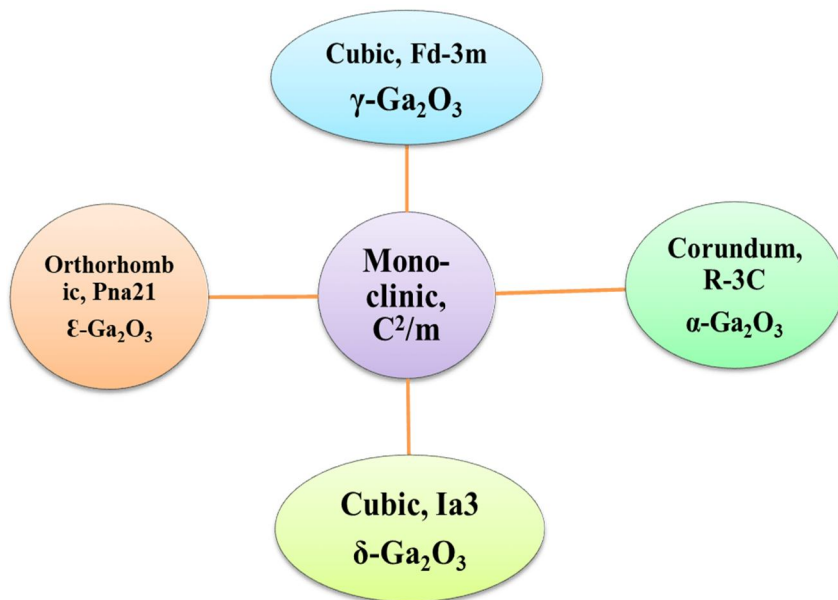


Figure 2 Interconversion of various phase of Ga_2O_3 .

The highest electrical field for breakdown region is related to them. The strength of reverse break down field is commonly used in FOMs, with scales which are expressed as the bandgap typically in the 2–2.5 range. The product of power frequency for RF amplification is known as Johnson's FOM (JFOM). A high current density is produced by a high electron saturation velocity. Ga_2O_3 broad bandgap allows it to operate in high temperatures conditions, and its large critical field allows it to operate in high voltages.

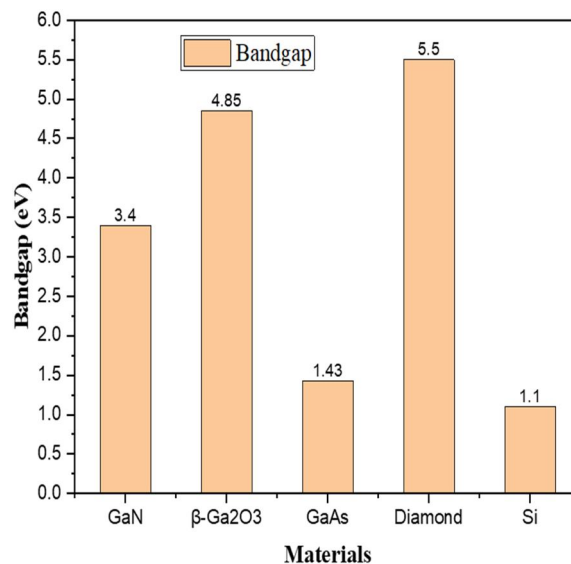
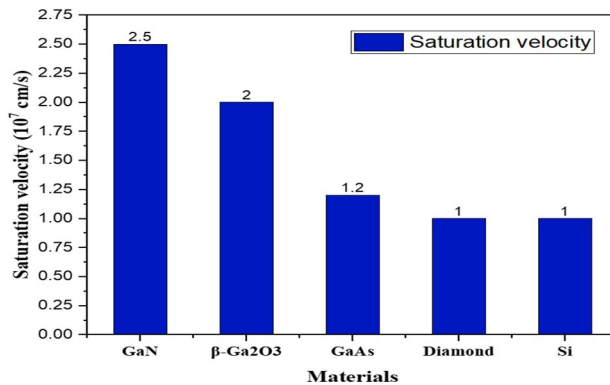
Table 1 provides a detailed comparative analysis of Ga_2O_3 with other wide bandgap semiconductors (WBS). Ga_2O_3 has a high FOM for low power at high-frequency devices switching operated in the frequency range of GHz, as seen in this table. When compared to Ga_2O_3 , the over cost of GaN substrates may limit their large term viability. Different semiconductors' suitability.

Table 1 Material comparison of different parameters-

Material parameters	Si	β -Ga ₂ O ₃	Diamond	GaN	GaAs	Unit
Electron mobility	1480	300	2000	1250	8480	(cm ² /Vs)
Saturation velocity	1	2	1	2.5	1.2	(10 ⁷ cm/s)
Baliga higher frequency	1	142.2	1501	100.8	10.1	-
Dielectric constant	11.1	10	5.5	3.4	1.43	-
Thermal conductivity	1.5	0.3	20	2.3	0.5	(W/cm K)
Bandgap	1.1	4.85	5.5	3.4	1.43	(AW ⁻¹)
Breakdown field	0.3	8	10	3.3	0.4	-

B. Thermal Characteristics Of β -Ga₂O₃

β -Ga₂O₃ has minimum thermal conductivities in comparison to alternative semiconductors like set on, sapphire and GaN. Its thermal physical phenomenon is half of magnitude and sapphire of order one smaller than GaN [6]. The thermal physical phenomenon in β -Ga₂O₃ is enthusiastic about its lattice direction owing to its crystalline property. it had been depicted that the best physical phenomenon at 010 diretion having the value 27 W/m-k in comparison to 100 direction lowest thermal phenomenon have 10.9 W/m-k [7,8].



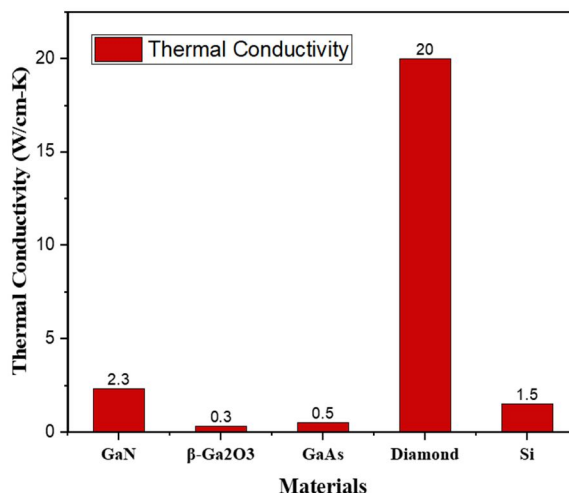


Figure 3 Analisis graph of different parameters on different materials.

III. GROWTH OF β -Ga₂O₃

A. Production Of β -Ga₂O₃ By Bulk Growth Method

Depending on device application of β -Ga₂O₃ there are various structural standards, doping of rare earth material exhibits. β -Ga₂O₃ substrates has glorious structural coordination and manageable doping areas unit crucial for realizing applied device applications. Production of good quality crystals of substrates is produced by EFG, floating zone [9,10] and Czochralski [11,12] ways. The production of substrat made by this method is scalable and low price [13]. β -Ga₂O₃ substrates show an n-type physical phenomenon that is meant to be owed to the Si impurity included Ga₂O₃ powder supply. Fe, Mg used as doping element for the production of semi insulating gallium oxide substrates [14,15].

B. β -Ga₂O₃ Thin Film Growth Method

β -Ga₂O₃ skinny Film Growth have fully grown by numerous ways together with MBE [9,16], MOVPE [17], HVPE [18], and LPCVD [19].

C. β -Ga₂O₃ MBE Growth Method

MBE is a method to decrease impurity level and produced good quality skinny films. It grows skinny films with low impurity levels to an ultrahigh atmosphere having vaccume and high purity. Production of β -Ga₂O₃ by MBE growth process is taken place by temperature changes in range 500⁰C to 800⁰C. For O supply, each O₂ [20], [21][22] and O₃ [23] area unit getting used. the expansion rates of MBE mature skinny films vary between 50 -180 nm/hr. The restricted rate of growth is thanks to growth dynamics related to the technique. Sources Sn/ Ge used as the doping material in the production of β -Ga₂O₃ by the process moleculaer MBE. [23], [24]. The use of Sn as acareer concentration varies in range of 10¹⁶ to 10¹⁹ [23]; whereas the carrier concentration has vary between 10¹⁸-10¹⁹ cm⁻³ exploitation Ge [24]. the most realizable quality up to now exploitation tin and Ge were ~150 cm²/Vs and 97 cm²/Vs, consecutively.

D. β -Ga₂O₃ MOVPE Growth

MOVPE business technique for manufacturing prime quality III-V nitride growing. Production higher volume material is produced by deposition process. MOVPE growth in β -Ga₂O₃ skinny films completing within the temperature varies between 550 °C-850 °C TMGa, TEGa, and high purity oxygen are used as sources. the expansion rates of the MOVPE mature skinny films vary within vary in range of 120 -750 nm. N-type doping of β -Ga₂O₃ films grown by MOVPE each doping material of Sn and Si were used [25], [26]. Therefore, laborious to grow skinny film have lesser doping concentration when higher dopant flow increment. In additionally procedures totally different defects within the skinny films that in turn lowers the fabric quality. Just in the case of Si, it forms SiO₂ thanks to the sturdy affinity of Si to O. Resulted, Si dopants aren't electrically active. the best-declared quality up to now was 130 cm²/Vs for Si-doped skinny films have the concentration of ~1x10¹⁷ cm⁻³ [25].

E. $\beta\text{-Ga}_2\text{O}_3$ HVPE Growth

HVPE is low cost-effective technique given by Japan which will manufacture the materials by the help of sensible crystalline quality and a quicker rate of increment. HVPE growth of $\beta\text{-Ga}_2\text{O}_3$ films are done at $\sim 1050^\circ\text{C}$ exploitation of metal chloride and oxygen as a precursors. Nitrogen is introduced as a carrier Gas. The fastest rate of growth reportable to this point is $\sim 25 \mu\text{m}/\text{hour}$, when homoepitaxial layer of $\beta\text{-Ga}_2\text{O}_3$ oriented at (001) direction substrates [27]. Semiconductor compound SiCl_4 used as economical dopant when N-type HVPE increment skinny film are produced. Thanks to the quick rate of growth, skinny films suffer from surface roughness. As result, an additional sprucing procedure is needed previous device process. Additionally, thanks to the use of GaCl as Ga supply, the skinny films show the prevalence of Cl impurity and defect.

F. $\beta\text{-Ga}_2\text{O}_3$ LPCVD Growth

It is a cheap technique that offers top-quality material with a quick rate, controlled doping and high quality [28]. $\beta\text{-Ga}_2\text{O}_3$ films are produced when temperature changes from 780°C - 950°C by LPCVD increment. It uses high purity gold Ga and O_2 gas because of the source. SiCl_4 shows N-type dopant behavior.

In range growth of $\beta\text{-Ga}_2\text{O}_3$ skinny films varied between $0.5\text{-}10 \mu\text{m}/\text{h}$ has been achieved through the LPCVD growth technique by dynamic the expansion parameters like growth temperature, pressure and precursor rate. Figure 4 shows the highest read FESEM image for heteroepitaxial accidentally doped (UID) $\beta\text{-Ga}_2\text{O}_3$ skinny film produced for 2h on the c-plane sapphire at 800°C . the skinny film consists of tiny domains that have pseudo polygonal shape morphology. The skinny film exhibits a thickness of $3.42 \mu\text{m}$. and provides a rate of $1.7 \mu\text{m}/\text{h}$ for this film. the complete breadth at 0.5 most (FWHM) of the curve is presented as 1.494° . temperature absorber spectrum is a basic parameter for understanding optical features of $\beta\text{-Ga}_2\text{O}_3$. Figure 4 shows peak absorption annum at 260nm which lies in deep ultraviolet radiation and production of gallium oxide film at 900°C . The skinny film incorporates a sturdy absorption within the deep ultraviolet radiation region absorption edge at around 260 nm .

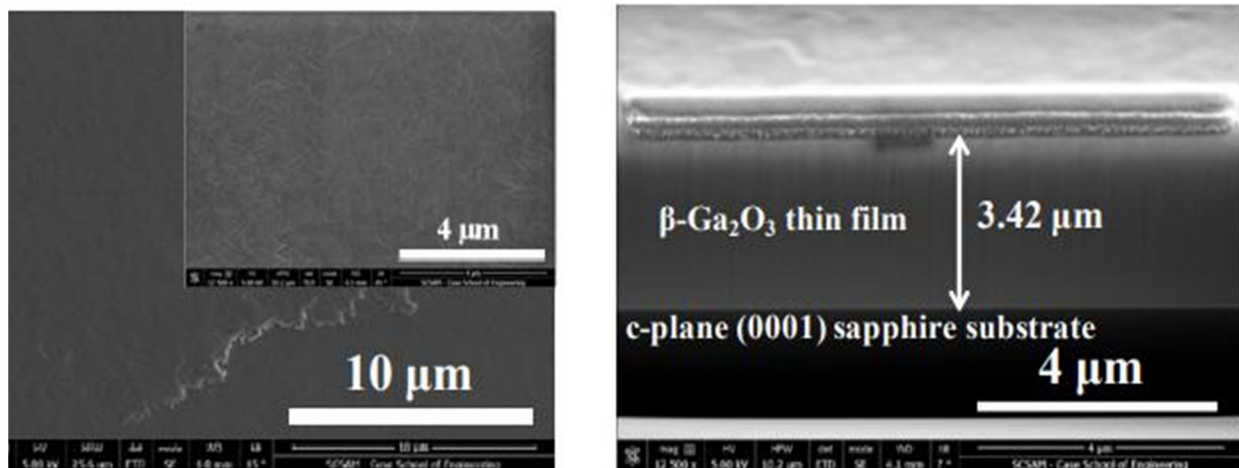


Figure 4 Top view and Cross-sectional FESEM presentation of $\beta\text{-Ga}_2\text{O}_3$. [29].

Electrical LPCVD grown method used for heteroepitaxial $\beta\text{Ga}_2\text{O}_3$ is best method to show electrical characteristics. The amount of carrier varies from 10^{16} to 10^{19} cm^{-3} with the help of change in doping supply rate. Value of measured space temperature Hall quality ranged between $8\text{-}42.35 \text{ cm}^2/\text{volt sec}$. With any optimization of the growth condition, the lepton Hall quality will reach $>100 \text{ cm}^2/\text{Vs}$ with a doping concentration within the low- 10^{18} cm^{-3} . By standardization of the expansion conditions, a similar rate for the homoepitaxial skinny films will be achieved. because of the heteroepitaxial ones. FESEM image of TEM ready by FIB from a homoepitaxial $\beta\text{-Ga}_2\text{O}_3$ skinny film. The crystal quality of the homoepitaxial skinny film was familiarised by an XRD curve. the XRD curves of (-42-2) reflection of the $\beta\text{-Ga}_2\text{O}_3$ homoepitaxial layer processed at temperatures of 900°C and 950°C . The XRD rocking curve full breadth at 0.5 most (FWHM) of (-42-2) peak for the layer fully grown at 900°C and therefore the substrate was 40 and 20 arcsec, severally..

Note that there no evidences thus far on achieving semiconductive Ga_2O_3 material with p-type dopant because of the expected giant ionization energies, presence of native defects (1).. The understanding of defects has been for the most part driven by initial principal calculations exploitation of totally different approaches [30].

IV. β -Ga₂O₃ DEVICES

A. Making Of β -Ga₂O₃

Etching required for intra-device in order to expose layers for successful contact. Studies should be carried out to fully understand the wet and dry etching of β -Ga₂O₃, as well as the associated process and effects the material characteristics. Any device that wants to deliver low contact resistance at moderate hardening temperatures needs high-quality contacts. Several I-V for based devices have been discovered to be only quasi-linear low current, highlighting the requirement of improved β -Ga₂O₃ contact techniques for many mature semiconductors..

Any semiconductor material gate insulator must meet three requirements: it must be thermodynamically stable with the semiconductor and not react during processing, it must have a high-quality interface with low defect and entice density, it must have sufficient band offsets to act as each lepton and hole barrier. The device's performance is mostly determined by the band offsets and kind of band alignment. The ultra-wide bandgap of β -Ga₂O₃ restricts gate dielectric market decisions to those having bandgaps more than 6 eV, such as SiO₂, Al₂O₃, HfO₂, ZrO₂, and LaAlO₃.. The use of β -Ga₂O₃ to measure band offsets of various dielectrics is still in its early stages. Additional print conditions optimization for patterning the dielectrics and improving their interface quality with β -Ga₂O₃ is still required..

β -Ga₂O₃ based power devices may require thermal control due to the fabric's limited and anisotropic thermal conduction. This problem can be solved by using heat sinks such as diamonds or transferring to a metal substrate.. direction presently being developed for GaN power physics. because β -Ga₂O₃ has a lower thermal conductivity than other wide bandgap materials, these techniques should be highly feasible for using β -Ga₂O₃ in high power devices.

B. β -Ga₂O₃ Field Impact Transistors

Field impact transistors (FETs) based on Ga₂O₃ have lately been explored due to its potential applications as next-generation physics.. FETs with a single Ga₂O₃ grown by MBE and MOVPE are indisputable. [31]. According to numerous teams, FETs based on slender flakes and nanomembranes exfoliated automatically from Ga₂O₃ single structure have also been developed. [32].

C. β -Ga₂O₃ Schottky Barrier Diodes

Because of the expected strong breakdown field of force (Eb 6-8 MV/cm) and low electron quality (200-300 cm²/Vs), β -Ga₂O₃ is expected to have a much higher Baliga's figure of merit (FOM) (Eb³, where is the relative insulator constant) than assault or GaN. β -Ga₂O₃ is based mostly on Schottky barrier diodes (SBDs), which have indisputable device properties. [33]. The best breakdown voltage so far produced by HVPE for β -Ga₂O₃ drift layer-based largely field-plated (FP) SBD adult is 1076 V. [34].

D. β -Ga₂O₃ Photodetectors

Deep-ultraviolet (DUV) solar-blinds with a cutoff 280 nm wavelength photodetectors (PDs) have gotten a lot of attention because of their capabilities in missile tracking, flame detection, and chemical/organic analysis, among other things.. Due to its perfect structure, a bandgap equivalent to 4.5-4.9 eV, and excellent chemical, mechanical, and thermal stability, monoclinic β -Ga₂O₃ is a good option for DUV PD.. As a result, in recent years, significant research on β -Ga₂O₃ has focused on completely solar-blind PDs. The active layers for PDs were β -Ga₂O₃ nanomaterials [36], thin films [37], and single crystals [38].. However, results of interband illness stages at the PD tool overall performance are nevertheless now no longer properly understood yet.

E. Ga₂O₃ Gas Sensors

Ga₂O₃ primarily based on thin films havestudied recently [35].Sensors related to oxygen feature primarily based totally on the truth that the conductivity of β -Ga₂O₃ skinny movies is inversely relation to the oxygen pressure withinside the surrounding . temperatures around 600⁰C, the oxygen sensitivity of Ga₂O₃ reduces considerably and it is able to rather be used to discover lowering gases such as hydrogen.

The H₂ brought about modifications withinside the electrical conductivity of Ga₂O₃ end result from the hydrogen at the complete process of the Ga₂O₃ with the next electron switch from the adsorbed hydrogen into Ga₂O₃.

However, it needs to be talked about that the reaction of the Ga₂O₃ sensor in the direction of lowering additives like ethanol can not be overlooked in contrast with oxygen reaction even at the excessive temperature of 800 °C The cross-sensitivity to lowering additives can be decreased with the aid of using extra catalytic or clear out.

V. Ga₂O₃ PHOTOCATALYSIS

Photocatalytic structures the use of sun strength have attracted an awful lot of interest because of their ability the comfort the environmental difficulties. Ga₂O₃ is the most intriguing photocatalyst substances since it has demonstrated excellent photocatalytic properties for a variety of processes, including water splitting, carbon dioxide reduction, and methane conversion [40], as well as the degradation of natural compounds.. The specific structures coordinatively unsaturated Ga³⁺ cations, which are regarded to be crucial for hydrocarbon activation in the CO₂ environment, are credited with Ga₂O₃ catalytic activity.

VI. III-NITRIDES of β-Ga₂O₃ EPITAXY

Regardless of the current advancement in bulk GaN unmarried crystal fabrication methods, GaN substrates are expensive and difficult . As a result, the majority GaN devices are made using heteroepitaxial of substrate such as sapphire, silicon.However, there are still challenging conditions with those substances, such as sapphire's insulating ability, which makes it impossible to produce vertical gadgets. In the case of SiC, extremely expensive and has a lot of optical absorption in the blue part of the spectrum. A significant thermal mismatch, chemical interaction with GaN within the expanded surroundings, and opaqueness in visible and UV spectrum are all concerns associated with silicon. Monoclinicβ- Ga₂O₃ is an excellent choice for serving as an enhanced substrate for III-nitrides because it combines the visible and conductive substrate. Excessive high-satisfactory bulk β- Ga₂O₃ crystals can be created more advantageously by melt-increase procedures such as Czochralski and EFG at a cheap value and high throughput.. As a result, various reviews on the synthesis of GaN epilayers on different orientations of β-Ga₂O₃ substrates using MOVPE, MBE [41], and HVPE have been published recently.

VII. OPTICAL CHARACTERISTICS OF Ga₂O₃

At a wavelength of 250 nm, Ga₂O₃ is visible optically. Ga₂O₃ has a large bandgap, which is most noticeable in the UV–visible range of spectrum. The color of the crystal might be affected by impurities, flaws, or varied specific boom circumstances [36]. The conductivity and optical residences of the mild spectrum have a substantial link in this state of affairs. Because of a few modest absorptions within the blue observed mild variation spectrum, insulated β-Ga₂O₃ crystals are either have no color or have a mild yellowish tint.

The optical transmittance spectra of Ga₂O₃ are considerably affected by different concentrations of free electrons [37]. Ga₂O₃ was discovered in the DUV spectral band at first. Transmittance spectra for crystals with no regard for electrons have absorption range in between 255–260 nm. With the help of improved the electron attention have origin from various contaminants, the absorption range have shifts toward the NIR(Non Infra red) wavelength region area with total transparency. The absorption spectrum is responsible for the transition from the VB (valence band) into conduction band, showing that the transmittance spectrum is between 255nm and 260nm. within the visible and NIR(Non infra red) wavelengths degenerate with affluence in loose electrons attention. On the wavelength area between 255 and 260 nm, a rapid cutoff absorption facet was detected [38].

The effect of optical transition strength on annealing temperature was previously demonstrated [39]. An change in bandgap ranges from 4.82 eV to 4.86 eV is caused by an excessive annealing temperature. UV–Vis-NIR(ultra violet-visible-infrared region) and photoluminescence (PL) spectroscopy are the optical characterization methodologies used. Changing the bandgap strength or optical residences is especially possible when employing different annealing temperatures. This location is particularly useful for evaluating Ga₂O₃ software in optoelectronic devices.

β-Ga₂O₃ emits three bands of light: UV (3.2–3.6 eV), inexperienced region (2.4 eV)and blue region (2.8–3.0 eV) [40]. The pattern practice technique and contaminants appear to have little effect on UV band emission. UV light coming from band facet recombination is implausible, as evidenced by the β-Ga₂O₃ bandgap of 4.8 eV. When loose electrons and self-trapped holes recombine, β-Ga₂O₃ will only appear in UV band. In β-Ga₂O₃ crystals, where Oxygen (O) vacancies are relates conductivity properties involved blue emission, A link between blue band depth and resistivity [41].

The recombination of electrons and holes by Hartwig and Kellendonk [42] allowed β-Ga₂O₃ to produce a blue moderate spectrum. However, the following doping with exact factors such as Be, Li, Fe, and Cu, the color of emission changes. These factors are known for their ability to change the wavelength of a blue color emission. According to O vacancy-associated transitions, PL(photoluminescence) spectra from Ga₂O₃ are commonly ruled using a large collection of transitions concentrated at about 399 nm at room temperature [43].

The majority of PL research does not any records in intrinsic emission inside the DUV(Deep Ultraviolet region) range (255nm–278 nm), but rather from the Ultraviolet (UV) range spectrum to the visible 350nm–600 nm. As a result, an ultraviolet-visible spectrometer is the best device used in determining the wavelength range based on the optical residences of all Ga₂O₃ polymorphs. Because of the asymmetry in crystal morphologies, the optical residences of Ga₂O₃ also exhibit high-quality anisotropy [44]. Ga₂O₃ optical absorption occurs at distinct intensity transitions range Td coordinated Ga and O. Pleochroism in the vapor phase is an example of Ga₂O₃ optical residences. With the use of incident light, the light gets polarized in six unique angles, the response has led to the boom of Ga₂O₃ unmarried platelets. Ueda et al. [45] studied the optical features of single crystals developed by floating Zone (FZ), as illustrated in Fig. 4, to observe the spectrum of light from various angles. A slight absorption range of 4.90 - 4.59 eV may be seen in the angles of polarised light at E/b and E/c, respectively. E/b and E/c, interfered by threshold wavelengths of 253 nm and 270 nm, respectively.

When the angle between c and E was increased in optical transmission spectra, the wavelength spectrum was lowered. optical features of natural Ga₂O₃ were still investigated using first-principles calculations based entirely on DFT in the generalized variation approximation used in Perdew–Burke–Ernzerhof method, Natural β-Ga₂O₃ is located between the Deep Ultraviolet (DUV)spectrum location (170–200 nm) with the best height absorption coefficient estimated as 2× 10⁵ cm⁻¹ using the simulation model. Therefore, their transmittance is positioned in the Deep Ultraviolet(DUV) region at around 260 nm to 300 nm, with unique polarisation angles, Because of the optical absorption spectra in Fig. 5, which have the same wavelength location. As a result, every change is related to optical transmittance and absorption spectrum houses. Furthermore, based on our previous DFT work [46], Ga₂O₃ exhibits a DUV position in its height emission range of 100 nanometer to 280 nanometer .

Fabric synthesis, flaws, and doping can all be used to advance the optical characteristics of β-Ga₂O₃. The optical transmittance of Ga₂O₃ will rise when annealing time is extended [47]. By utilizing the low awareness of unfastened electrons within the dopants, Czochralski's approach gives excellent optical transmittance of Ga₂O₃ crystals [48].

The optical characteristics of Ga₂O₃ can also be obtained via the epitaxial approach, particularly within the metastable portion of β-Ga₂O₃. In the 4.9–5.6 eV range, the optical bandgap of α-Ga₂O₃ is marginally greater than that of β-Ga₂O₃ [51]. On the conduction band minimum, the band shape of α-Ga₂O₃ is similar to that of β-Ga₂O₃ is a very dispersive Ga 4s orbital nation (CBM). The valence band is well-known for having the same flatness as β-Ga₂O₃, which is found on the O 2p orbital nation. implies that β-Ga₂O₃ has a 5.39 eV oblique bandgap electricity.

Only a few investigations have been proposed into the optical homes of β- Ga₂O₃ and Y- Ga₂O₃ crystal systems. According to a recent study on the optical features of band gap for theβ - Ga₂O₃ crystal form, the valence band minimum is known for comparable flatness and a significant dispersion relation CBM. [52]. The computed optical bandgap is roughly 4.26 eV, according to Heyd–Scuseria–Ernzerh of relevant theory. The optical direct and oblique bandgaps of Y- Ga₂O₃ the crystal form are 5.30 eV and 5.15 eV [49].

The determination of a positive hue of the mild emission spectrum from various doped elements is a crucial component of Ga₂O₃optical properties. Every doping information of Ga₂O₃is listed in

Table 2 with the color and wavelength associated with it. With a transition metal, unusual earth, Ga₂O₃can display strong PL from wavelength emission. Eu³⁺, Co, Cr, and Li all have a red color emission. Sn, Ce, and Tm, on the other hand, emit a yellow tint. Furthermore, Er, Ho, and Mn emit a green color.

Table 2 Emission spectrum of light with different doping elements.

Emission Light colour	Doping Element	Wavelength emission
Blue	Dy, Cu, Eu ²⁺	450-495 nm
Green	Er, Ho, Mn, Tb	495-570 nm
Red	Co, Li, Eu ³⁺	620-750 nm

Yellow	Sn, Tm, Ce	570-590 nm
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Through Eu^{2+} and Dy-doped Ga_2O_3 , a blue color emission is given. Ga_2O_3 is enhanced by these doping elements in thin-film electroluminescence (TFEL) cells in digital display panels. As a result, inside the multicolor emissions of TFEL devices, high-depth luminescence can be obtained by using Ga_2O_3 with different doped values.

It has been given that monoclinic Ga_2O_3 in nanoflake form emits at 2.0 eV (red emission band) and 3.8 eV (blue emission band) (UV band). O and N vacancies, which are connected to the donor as well as acceptor levels in the establishment are responsible for the emission on the red band.

The source of the 3.8 eV emission, on the other hand, is yet unknown. Different emission peaks must be seen in the UV (3.3 eV), green, and blue areas of Ga_2O_3 layers produced using sapphire substrates employing HVPE [50]. The emission peak of the blue emission band was between 2.8 and 3.0 eV, while the green band at 2.4 eV.

transition between donors and acceptors given by the Oxygen(O) and Gallium (Ga) vacancies is shown by the green and blue peaks, respectively.. The intrinsic conductivity of Ga_2O_3 is n-type, which is ascribed to the recombination process [51]. Near the fascia's emission, which compensates for the deep levels [52]. Figure 6 shows the temperature-dependent cathodoluminescence of undoped Ga_2O_3 in the blue, green, and ultraviolet (UV) bands. The UV band's peak intensities fall as the temperature rises.

The temperature rise is almost unaffected. At 300K green and blue emissions predominate, allowing $\beta\text{-Ga}_2\text{O}_3$ to be manipulated usec for light-emitting optoelectronics appliances. The mechanism of the emission process is related to donor-acceptor pair (DAP) recombination [53]. The distance range between the donor atom and acceptor atom has a significant impact on the recombination timing of DAP emissions. The DAP band is comprises fluctuated energy associated with the Coulomb force contact between donors atom and acceptors atom during recombination. Because of the statistical fluctuation of the internal fields created by the density change of charged impurities, this substantial spatial fluctuation may cause further line broadening at the band's margins.

VIII. OPTOELECTRONIC APPLICATIONS OF Ga_2O_3 NANOSTRUCTURES

Ga_2O_3 nanostructures include nanowires, nanorods, nano blocks, and nanosheets, which are all low-dimensional crystalline Ga_2O_3 [54]. due to its compact size, high sensitivity, and quick response times. Additionally, adding dopants to Ga_2O_3 can improve its electrical and optical properties, increasing its performance efficiency.

Many methods for generating Ga_2O_3 nanostructures have been examined, with the vapor-liquid-solid (VLS) technique being the most prevalent [55]. Supersaturated droplets are generated in this procedure, and metal alloys are used to dissolve the vapour component. During the development of the nanowires, the VLS process causes a solid phase to precipitate.

Using various types of catalysts, Ga_2O_3 nanowires may produced on substrates by using the CVD process [64]. Au is employed as a catalyst to increase Ga_2O_3 formations in nanowires, for example. The CVD process, like the hydrothermal method, is dependable and produces Ga_2O_3 structures of reasonably high quality. Ga_2O_3 nanostructures can be made through physical evaporation, laser ablation, organometallic CVD (MOCVD), and vapour phase epitaxy (VPE).

Apart from the VLS and CVD processes, there are other ways to generate high-quality Ga_2O_3 nanostructures. Another well-known approach is the hydrothermal method, which was used by Ryou et al. [56] to make Ga_2O_3 Sn doped nanostructures. When compared to the pure structure of Ga_2O_3 , this approach resulted in a considerable increase in photocatalytic activities of Ga_2O_3 Sn doped under use of UV irradiation of 254 nm. Furthermore, Ga_2O_3 nanostructures created uses the hydrothermal technique enable low-cost, simple, and easy-to-use nanostructure synthesis.

A field-effect transistor (MOSFET) construction with a thin layer of polycrystalline $\beta\text{-Ga}_2\text{O}_3$ back conductor for an optoelectronic device [57]. Sn dopants will replace the Gallium (Ga) atoms, allowing the device to more electrically capable a low current density of 21 mA/mm and exhibit power electronics characteristics with treble exhibiting good light emission photoresponse at 254 nm, indicating the potential application for solar shade photodetectors. Meanwhile, Ga_2O_3 has benefits over other typical broadband semiconductors in terms of optical features, such as very inexpensive ways of producing single-crystal structures and intrinsic sun blindness. Emissive display applications, such as TFELs, Schottky Barrier Diodes (SBDs), optoelectronic devices, such (LEDs) are examples of Ga_2O_3 -based devices.

The Ga_2O_3 based solar-blind UV photodetector [58] is one of the most used optoelectronic applications. This gadget is commonly used in the military for missile early warning and UV communication. [23] Fire alarm and UV intensity sensing are some of the other applications [59].

The invention of a Ga₂O₃-based solar UV blind photodetector to help identify the presence of coronaviruses also has a lot of promise [59]. Recent improvements in solar cells are primarily focused on decreasing the effects of global warming and the greenhouse effect induced by continued fossil fuel use [60]. In terms of processing, the latest generation of solar cells is predicted to improve.

IX. SOLAR-BLIND UV PHOTODETECTORS

Ultraviolet (UV) photodetectors that are solar-blind are insensitive to infrared (IR) and closely UV radiation. However, sensible to UV wavelengths lower than 300 nm [61]. Solar-blind UV photodetector's primary function is to prevent visible light while transmitting Ultraviolet radiation by using different resources.

SBDs [62], photomultipliers [63], and photodiodes [64] represent current properties of solar-blind UV photodetectors. In the future, the solar-blind camera will be used to show power lines and identify electrical leakage in transmission cables. [65].

Suzuki et al. [66] presented the first solar-blind UV- Ga₂O₃ photodiodes. They have a semiconductive (100)-oriented β-Ga₂O₃ crystal structure, which they generated using the optical FZ approach. On the other side of the β-Ga₂O₃ crystal, Au-Schottky contact, Ti/Al resistance unit contact are used. It entails hardening at 200⁰C to improve the quality issue from 1.1 to 1.2 at 400⁰C, as well as increasing the responsivity rate of the solar-blind actinic radiation photodiodes by magnitude up to 10⁶ in the presence of 254 nm light. This strategy will boost the device photocurrent and reverse bias voltage.

The performance of β-Ga₂O₃based optoelectronic devices can be improved by fabricating an ultrawide bandgap Ga₂O₃employing grouping passivation [67]. As a result, for high-speed nanoelectronic devices, a low-dimensional structure of - Ga₂O₃ identical to the second with grouping passivation, may be obtained [68]. The same research also yielded useful information for developing better p-type Ga₂O₃optoelectronic devices. Furthermore, 2D-Ga₂O₃ structures will increase the absorption range of actinic radiation, expanding the optical spectrum's absorption range.

MBE was used by Guo et al. [69] to build a high-performance device with have vertical p-n heterojunction solar-blind photodetector. On a p-type (100) Si substrate, a (-201)-oriented - Ga₂O₃ was large, eventually generating p-n heterojunction solar-blind photodiodes. Conductors were made by depositing Ti/Al and Au on either side of the Ga₂O₃ layers. dark current magnitude of 8.5×10⁷ A, photocurrent magnitude of 8×10⁴ A, the electrode operation is maximized in 254 nm lightweight condition and 3V reverse bias. At 254 nm, the photocurrent to dark current magnitude relationship was 9.4×10² A. At 365 nm, value was reduced to 6.2×10² A. Under ideal conditions of 254 nm and 3V reverse biasing voltage, maximum responsiveness can approach 370 A/W.

Liu et al. [70] employed the MBE approach to establish another manufacturing methodology for a photodetector with a solar blind. On an Al₂O₃ (0001) substrate, they imply a substantial (-201)-oriented -Ga₂O₃ layer. The resistance unit of this solar-blind UV photodetector valued 20 V biasing voltage. The dark and photocurrents are 0.04 and 438 nanoamperes, respectively. Within the spectral range of 210–280 nm, the photocurrent peak was 235 nm, which corresponds to the optimal range of light The maximum photoresponsivity was 259 A/W correspond 20 V, with rising and decay times of 0.02 seconds.

Using PLD to manufacture a high-quality Ga₂O₃thin film, an improved solar-blind photodetector was described [79]. Film thickness can change the surface roughness of the film, but it has no effect on grain size.. At the same bias voltage, the photocurrent was 16 A. Under the irradiation of a hydrogen atom lamp 4 millisecond and 104 milli secondScorespond to rise time and decay timming, respectively.

He et al. [71] revealed a novel property when dual-band photodetector in combined β-Ga₂O₃ and black phosphorus heterojunction of p-n diode . MOCVD was used to generate the β-Ga₂O₃ layer heteroepitaxial on sapphire substrates, while mechanical exfoliation was used to deposit the BP layer. For the spectrum of IR and UV the made-up device had an honest spectral value of 88.5 mA W⁻¹ and 1.24 mA W⁻¹, respectively. It illustrates the extraordinary potential of combining Ga₂O₃ with other superior materials to increase photodetector capabilities on the UV spectrum far side.

MSM solar-blind UV (Ultraviolet) photodetector [72] to build the Ga₂O₃ slim film on a glass substrate, several O pressure values is being used. The β-Ga₂O₃ thin film can then be employed to make a solar-blind UV photodetector's MSM structure. As the degree of O pressure rises, so does the responsiveness and response speed. At 50mTorr, this MSM UV photodetector corresponding high responsivity rate of 5 A/W. The detection value up to 10¹² Jones to see the state of the incoming light is another novel feature of this MSM solar-blind photodetector. During the fabrication, Oxygen pressure should be carefully monitored to achieve the best results and construct a more advanced form of the sunlight transport for superior solar-blind photodetectors to be used.

The use of MgZnO UV photodetector obtained using RF thermionic valve sputtering was described by bird genus et al. [73]. At a voltage of -5 V biasing is applied, the low- maximum value of photo-dark current ratios were 5.93×10¹¹A and 5.69×10⁴A concurrently. Due to the photoconduction effect, this device's external quantum potency was 63.3 %.However, this specific UV photodetector has a number of flaws that might cause dark current to flow out of the MgZnO MSM structure solar-blind UV

photodetector, affecting the responsivity magnitude ratio of UV to visible photon spectra. The characteristics of a - Ga₂O₃ solar-blind UV photodetector along with surface plasmon polariton (SPP) produced an Au ultrathin film that was undisputed [74]. The SPP method was used to increase the device's physical phenomenon qualities. An improvement in photoresponse was seen irradiation of 254 nanometer and 532nanometer, resulted that the photoelectric features improved.

Mistreatment of the polymer-assisted deposition (PAD) technology resulted in a full-grown Ga₂O₃ layer on a c-plane sapphire . [75]. The Ga₂O₃solar-blind UV photodetectors manufactured using this method have a smaller dark current and a shorter reaction time than those made using other procedures, likely nonaggressive CVD, Molecular beam epitaxy and PLD. With an applied bias, its responsivity was 4.2×10³ A/W. The voltage might be as high as 20 volts.

Table 3 contrast the performance of solar-blind UV that will be researched in the coming years. Varied types of Ga₂O₃ based heterojunction devices have different detectivity, UV rejection magnitude relation, rising time, decay time, dark current, and photocurrent to dark current ratio (I_{photo}/I_{dark}).. The expansion and fabrication procedures of heterojunction devices are two different elements that will have an impact on the aforementioned characteristics.

Table 3 Comparison of performance of β-Ga₂O₃ UV photodetector with Growth method.

Types of Heterostructures	Detectivity(jones)	Rise time (s)	Decay time (s)	Spectral responsivity (AW ⁻¹)	I _{light} /I _{dark} Ratio	Method of Growth
β-Ga ₂ O ₃ thin films	1.22 × 10 ¹⁵	-	5.0× 10 ⁻¹¹	190.08	>10 ³	CVD
β- Ga ₂ O ₃ thin films	-	0.32 × 10 ⁻⁶	1.42 × 10 ⁻⁴	0.102	6.04× 10 ⁴	PLD
β- Ga ₂ O ₃ thin films	-	0.286	0.05	4.2 × 10 ⁻³	-	PAD
β- Ga ₂ O ₃ thin films	4.8 × 10 ¹¹	-	-	0.72	>10 ⁴	Thermal-assisted conversion
ε- Ga ₂ O ₃ thin films	1.2 × 10 ¹⁵	-	0.024	230	-	MOCVD
ZnO/ Ga ₂ O ₃	6.29× 10 ¹²	10 ⁻⁴	9 × 10 ⁻⁴	9.7× 10 ⁻³	-	CVD

X. LEDS

Ga₂O₃ is the most extensively used for manufacturing of LEDs due to Deep ultraviolet (DUV) spectrum region and n-type semiconductor characteristics. The LEDs were driven using a variety of nitride substrates, including GaN, InGaN, and AlGaN. The Ga₂O₃ crystalz and nitride substrate has a smaller offset than sapphire substrates, resulting in reduced stress and flaws at the interface. TCO electrodes were used in AlGaN-based UV LEDs The ITO Ga₂O₃, and Ag in a TCO electrode combine to produce an ITO/ Ga₂O₃/Ag/Ga₂O₃ multilayer, familiar to the MSM structure. LEDs are also covered by MSM. MSM layer has specific resistance value of 2.36×10⁻³ cm² and bandgap energy 5.11 eV, gves 92.8% transmission correspond to 365 nm wavength . The MSM structure sheet resistance. Is refduced by making Ag diffusioin layer. o AlGaN-based LEDs improved their electrical and optical parameters as a result of the suggested research.

Lee et al. [76] developed pin-transparent DUV LEDs using an active-emitting i- Ga₂O₃ thin film.. This is the first study to look into the possibility of Ga₂O₃-based metal oxide leads. LED structure made by InGaN was designed with a low-efficiency approach is used to stop non radiative process of combination at higher density [77]. The construction of vertical InGaN/GaN (MQW) multi-quantum well LEDs (VLEDs) on a Ga₂O₃substrate was developed for further research on this droop suppression application [78]. VLED has good optical efficiency, and the decreased effect aids in uniform heat distribution, decreasing the device's self-heating effect [79]. LEDs' total operating efficiency has been enhanced, and their possible uses have been expanded to include UV, yellow-green, blue, and infrared LEDs. Complex processing techniques, such as lift-and-transfer structures [80] vertical LEDs based on, are not required for fabricating devices employing this technology. AlGaN grown on Ga₂O₃ substrate has shown outstanding vertical stability.

With a peak quantum efficiency of more than 78% AlGaN grown on -βGa₂O₃ substrate has shown good vertical injection and emission of n-side. Due to the increasing possibility of radiative recombination pathways, quantum efficiency I,proved with injection current.GaN/AlGaN MQW structures built on an orientated Ga₂O₃ (- 201) substrate have been described [81]. When

contrast in sapphire substrate, the reduced density of dislocation defects achieved on β -Ga₂O₃ led in better structural and optical capabilities..

In comparison to the planar LED, the nanorod LED has a tiny offset from the maximum position in the PL measurement. It also outperforms other planar and traditional LEDs in terms of light intensity.

The Ga₂O₃ layer's flaw elimination and transparency enhancement are the mechanisms behind this construction. However, further researches needed to increase the SNR of LEDs, which will improve overall stability and efficiency. Density dislocation and leakage current, which are smaller in modelled LEDs than in planar LED systems, are another illustration of the differences between modelled and planar geometries. [82]. The modeled LED quantum efficiency is also higher than that of planar arrangements.

When modeled LEDs were compared to planar LEDs, non-radiative recombination caused by high vector density becomes forward at a lower vector density. The sapphire substrate model for growing thin Ga₂O₃ films can lower the energy barrier in LEDs, allowing more current to pass [83].

Zhou et al. revealed that Ga₂O₃ [84] based AlGa_N UV LEDs with a specific resistance at contact about $2.36 \times 10^3 \text{ cm}^2$ may achieve up to 93 % transmission at 365 nm. The bandgap energy correspond to 5.11 eV is achieved by Ag diffusion in the ITO/ Ga₂O₃ multilayer. As a result, doping of Ag element AlGa_N-based LEDs reduces their optical properties. In Ga₂O₃ LEDs, rare earth metals like Erbium Er can be used as a doping [85]. green-yellowish emission spectrum lies between 520nm-600nm . Furthermore, the Electroluminescence(EL) measurement exhibits emission peaks that are comparable to those observed in the photoluminescence measurement. This discovery demonstrates that the device is capable. When electrically pumped, they emit at visible wavelengths, and so have a lot of depth in high-powered LED applications.

Rare earth elements, like Lutetium and Europium , were used to fabricate Ga₂O₃-based LEDs in one work [86]. In range of 300 nm to 800 nm correspond to visible light range achieve optical transmittance was 83 % . These rare earth LEDs have bandgap energy of 3.96 eV, indicating that they can absorb a lot of light. Another benefit is the lack of interface cracks.

Another well-known application of the MSM semiconductor structure is in the manufacturing of solar cells. The MSM semiconductor heterostructure mechanism is used in solar cell design [87] to reduce the electric field's internal resistance and, as a result, increase electrical conductivity. The use of thin oxide buffers with the Cu₂O absorber layer, such as β -Ga₂O₃ has decreased the conduction band offset difficulties . Inadequate efficiency is typically connected with [88]. Rizi et al. [89] created a model of a Cu₂O heterojunction solar cell with β -Ga₂O₃ used as active material.

XI. CONCLUSION AND FUTURE SCOPE

Several substantial problems face the field of Ga₂O₃ based optoelectronic devices research. Decrease in thermal conductivities and anisotropy in crystal structure, as well as electrical, and optical character of Ga₂O₃, are among these concerns. The doping method can be used to solve almost any problem. Doping elements such as Magnesium (Mg), Arsenic, Nitrogen (N) can be included radically alter Ga₂O₃ intrinsic characteristics [90]. P-type doping, for example, allows for shallow acceptor and hole processes. The Ga₂O₃ structure allows for conduction. With a p-type doping element, this process will make Ga₂O₃ electrically insulated. As a result, the future focus of β -Ga₂O₃ based optoelectronic device development is expected to be on p-type doping improvement. Adjusting the orientation to optimized surface energy [91] is another solution to Ga₂O₃ anisotropic characteristics. The substrates (010) and (001) have always been employed in the growing process. Changing the direction of Ga₂O₃ can have a big impact. Its anisotropic electrical conductivity and optical absorption efficiencies should be increased. The majority of research on this topic is still centered on determining the optimal Ga₂O₃ orientation to maximize device efficiency. Additionally, this treatment can aid in improving performance. Indium oxide (In₂O₃) and Al₂O₃ are examples of other III-V materials. What has been Ga₂O₃ most compelling feature? Ga₂O₃ has high thermal improved breakdown voltage, and ultrawide bandgap (UWB) energy also improved , according to present researches. Ga₂O₃ has an outstanding FOM for high power device and large speed applications due to its physical characteristics. Bulk Ga₂O₃ substrates, on the other hand, may be mass-produced and made easily and available at a reasonable cost. Assisting in the production of more homoepitaxial Ga₂O₃ devices Ga₂O₃ substrates are simple to use in optoelectronic device applications. To generate (AlGa)₂O₃ or (InGa)₂O₃ heterostructures, combine with additional metals such as Al and In. These substances are very common. High-performance optoelectronic devices are made from a variety of materials. Ga₂O₃ is used in the production of high-performance solar cells and LEDs also has a lot of promise. Additional study and effort are being put towards achieving goals, including the use of Ga₂O₃ as buffer for solar cells. layer [92] and Ga₂O₃ and organic materials hybrid methods [93]. Ga₂O₃ is used in optoelectronics for a variety of reasons. The goal of technology like LEDs , solar cells are used to reduce electrical consumption and so advance towards further sustainable development.

XII. SUMMARY

The characteristics of Ga_2O_3 and their applications in optoelectronic devices application were the focus of this review. Polymorphism, material characteristics, optical properties of Ga_2O_3 are all covered. Ga_2O_3 thin-film applications are also reviewed, with a focus on sun-blind photodetectors, solar cells and LEDs. The available of bulk substrate is a key benefit of $\beta\text{-Ga}_2\text{O}_3$.

The performance of semiconductor devices is determined by a number of factors. Because $\beta\text{-Ga}_2\text{O}_3$ is particularly sensitive to detecting dislocation density, it is used to study its crystal structure. However, some difficulties, such as limited access, must be inscribed. To increase the characteristics of Ga_2O_3 -based devices, thermal conductivity and value of phonon scattering must be included.

It is developed during the last few decades as a material that tolerate high temperature range, perform well in power electronics device applications, and exhibit strong breakdown -electric- strength of greater than 1 (keV) [94], and it is also useful in solar-blind -Ultra violet (UV) light prediction [95]. therefore results there are still some concerns about using Ga_2O_3 as a semiconductor device material. Thermal management in power electrical devices is one of the most serious issues with Ga_2O_3 . The use of Ga_2O_3 in the development. The topic of optoelectronic devices has been fully addressed. The majority of solar-blind UV(Ultra violet) photodetectors are made up with heteroepitaxial materials $\beta\text{-Ga}_2\text{O}_3$. planar configuration with various materials, metal-semiconductor, p-n junction electrode geometries is used to make optoelectronic devices.

LEDs having $\beta\text{-Ga}_2\text{O}_3$ wmission in Deep ultraviolet region(DUV) up to the range of visible spectrum is recorded by various researchers. When GaN based LED is epitaxially grown, they can be used as a buffer layer. Because Ga_2O_3 and GaN exhibit same lattice constant numerical values, the problem related to strain at the contact is eliminated or reduced. VLEDs have a lot of potential because of their high output power and decrease in input power. The advancement of solar cell using Ga_2O_3 is fascinating topic. The present state of solar cell research and performance were discussed, with a focus on using Ga_2O_3 as a passivation layer. Despite the extensive evaluations and tremendous progressive increase made in Ga_2O_3 , much work remains to be done in order to achieve a mature and optimized technologies. Doping, for example, is a problem. To fully realize the potential of Ga_2O_3 , particularly in the optoelectronic industry, research and fabrication methodologies should be made. The current state of research in the investigation of $\beta\text{-Ga}_2\text{O}_3$ as a prospective contender for diverse applications is summarised in this publication. Recent advances have been made in bulk and thin-film growth, defect and impurity control, and other areas. Furthermore, it is critical to comprehend the impact of different growth factors on the optical, electrical characterization of $\beta\text{-Ga}_2\text{O}_3$. Fabrication for good quality Ga_2O_3 thin films is a topic that should be investigated more in the future.

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